

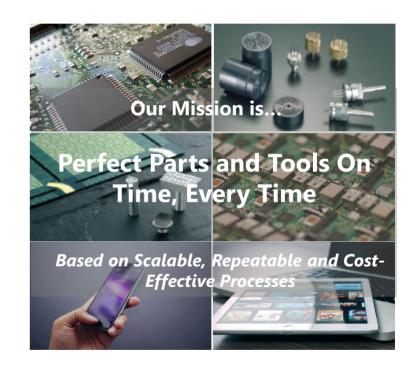


Business & Industry

Chris Borch, CEO Low Ming Wah, COO

Corporate Overview

- Founded in 1983 in Singapore
- Design and manufacture high precision tools and parts used in process-critical applications for the wafer-fabrication and assembly processes of the semiconductor industry
- Serve a worldwide base of customers from five facilities in Asia (Singapore, Malaysia, China, Philippines) and the USA
- More than 600 active customers
- Listed on the Singapore Exchange (Main Board) since 2003
- Committed to generating shareholder returns



Business Model

HIGH PRECISION, PROCESS-CRITICAL

Parts and Tools for Semiconductor Industry



Proprietary consumable tools used in the **assembly and testing of semiconductors**, such as die-attach and wirebonding tools

Contract manufacturing of precision parts used in process-critical applications for the wafer fabrication industry



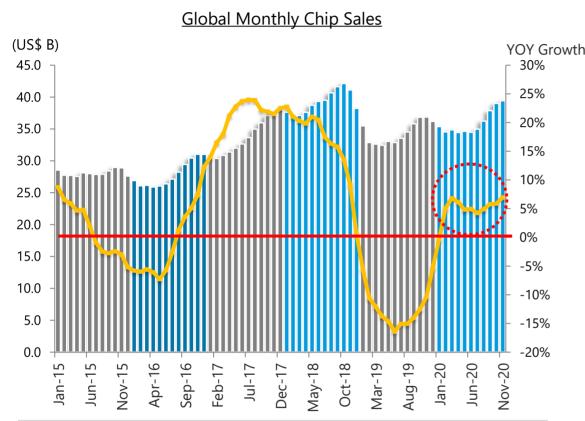
IDMs, Semiconductor assembly and test service providers

Leading wafer fabrication equipment manufacturers



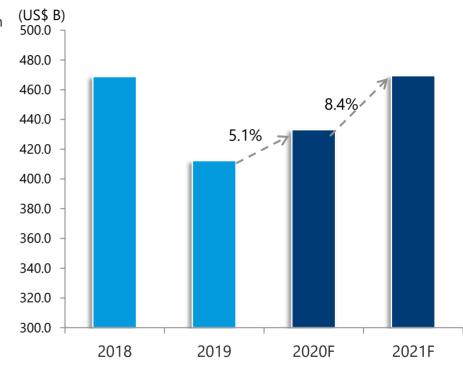
HIGH PRECISION AND QUALITY | SHORT CYCLE TIME | WORLDWIDE SUPPORT | VALUE > COST

Semiconductor Industry Review



Global semiconductor sales for the five months from July to November 2020 increased 5.8% year-on-year to US\$190.7 billion. The Semiconductor Industry Association said annual sales in 2020 are tracking well ahead of the total from 2019, despite substantial headwinds caused by the COVID-19 pandemic and other macroeconomic factors.

WSTS Semiconductor Sales Forecast (Dec 2020)



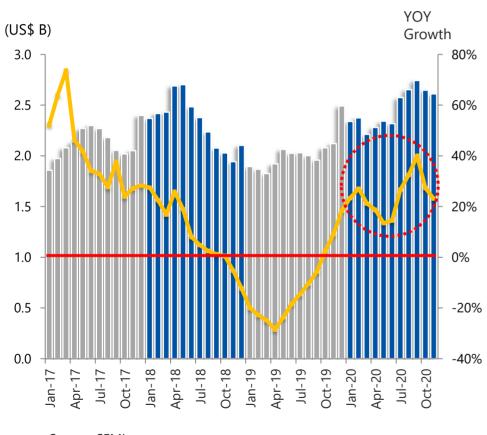
WSTS revised its growth projection for global semiconductor sales upwards to 5.1% in 2020. Global semiconductor market is expected to grow 8.4% in 2021, driven by double-digit growth of Memory and Optoelectronics.

Sources: Semiconductor Industry Association, World Semiconductor Trade Statistics



Semiconductor Industry Review

Three-month average of worldwide billings of North American equipment manufacturers

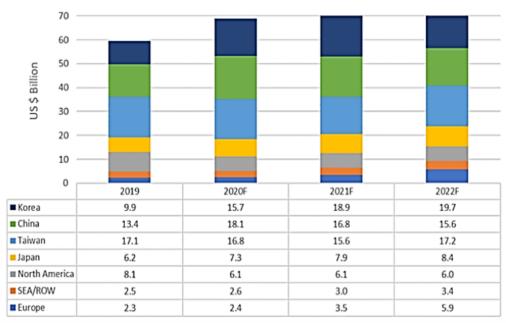


Source: SEMI

Micro-Mechanics 1H21 Results Presentation

Global Semiconductor Equipment Sales Forecast (Dec 2020)





- Global semiconductor manufacturing equipment sales projected to increase 16% and register a new record of \$68.9 billion in 2020
- Growth is expected to continue to reach \$71.9 billion in 2021 and \$76.1 billion in 2022
- Expansion is expected to be driven by both the front end and back end semiconductor equipment segments



RAISED INTERIM DIVIDEND BY 20% TO 6.0 cents
PER SHARE

RECORD REVENUE

S\$36.9M

16.7%

GROSS PROFIT MARGIN UP TO

54.3%

RECORD NET PROFIT

S\$9.1M

33.0%

Most of our global factories were operating at normal levels during 1H21



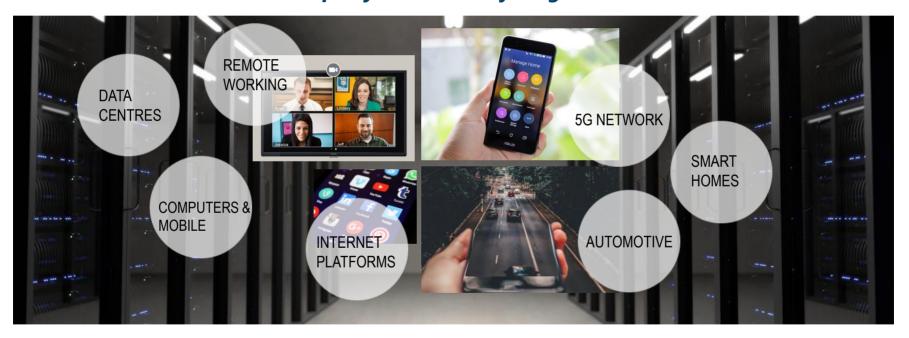
Amid a challenging period, we worked diligently to establish new procedures, implement safety protocols and fully comply with the COVID-19 orders to keep our people safe and our plants running.

However, rapidly changing markets, political and social turmoil, and possibility of production suspension due to COVID-19 pandemic make it difficult to predict business conditions in short-term.

Hence, we remain mindful of the need to build an organisation that is decentralised, flexible and resilient

The semiconductor industry has been remarkably resilient against a challenging macroeconomic backdrop

Indeed, we believe the semiconductor industry may be entering a Supercycle of multi-year growth



For Long-term Success and Sustainability, we have put in place goals, structures and processes to adjust quickly to changes in circumstances, and will continue to seize opportunities that come into view.

SEIZING OPPORTUNITIES FOR LONG-TERM SUCCESS AND SUSTAINABILITY

We plan to place even greater emphasis on several existing **operational methodologies** which have been beneficial to the Group over the years. These include:

"8S HOUSEKEEPING"

- Industrial management system
- Improve efficiency, safety, sustainability and foster culture of employee engagement and continuous improvement

2.

"24/7 MACHINING"

- Engineering methodology we developed 10 years ago
- Address inherent limitations of CNC technology and made "lights-out" machining possible

3.

"KEY PROGRESS INITIATIVES (KPI)"

- Planning & management tool
- Set priorities and performance expectations by clearly defining key problems, goals, required outcomes and accountabilities

SEIZING OPPORTUNITIES FOR LONG-TERM SUCCESS AND SUSTAINABILITY

ACCELERATE CAPITAL INVESTMENTS

- Adjusted the timing of some of our capital expenditure during the last nine months, due to a lack of business visibility caused by the COVID-19 pandemic
- Decided to **accelerate several key investments**, resulting in total capital expenditure of S\$5.3M in 1H21:
 - Includes S\$2.0M investment to develop a new machining technology
 - Essential for making the next-generation of parts for wafer-processing equipment that are designed to fabricate chips with geometries measuring well below 10 nano-meters
- Raised our capex budget for FY2021 to S\$7M in view of the positive outlook for the semiconductor industry

ENSURE LEADERSHIP CONTINUITY

- Began an engineering internship program a few years ago to develop the technical and leadership team to ensure continuity
- **Kyle Borch**, son of founder, joined the USA operations in 2018. He holds a B.Sc. in Physics and double M.Sc. in Mechanical Engineering and Engineering Management.
- Kyle currently leads an eleven-person technical team responsible for tools, fixtures and other critical engineering support functions.
- Also plan to continue working to refresh and strengthen our Board for sound corporate governance



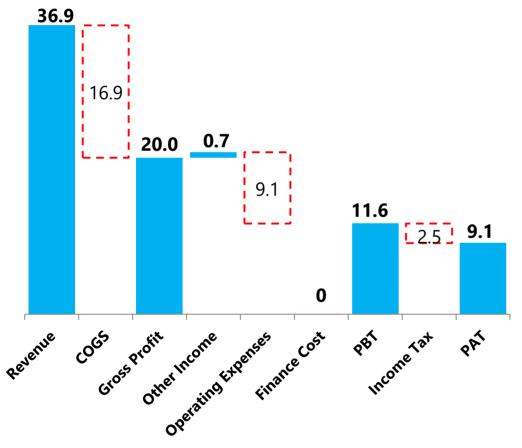
Financial Review

Chow Kam Wing, CFO



1H21 in Review

1H21 P&L Overview (S\$ million)



N.B. Due to rounding, some totals (in this and the following slides) may not correspond with the sum/subtraction of separate figures.

KEY RATIOS & STATISTICS

REVENUE GROWTH	16.7%
GROSS PROFIT GROWTH	18.2%
PBT GROWTH	28.4%
NET PROFIT GROWTH	33.0%
GROSS PROFIT MARGIN	54.3%
NET PROFIT MARGIN	24.7%
EARNINGS PER SHARE	6.55 cents
DIVIDEND PAYOUT (1H21)	92%
RETURN ON EQUITY (annualised)	32.0%
CASH	S\$21.1M
BORROWINGS	Zero

FY: Financial year ending 30 June

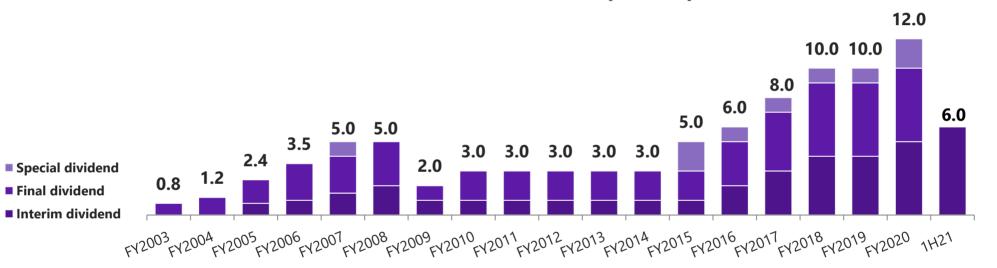


Dividend Performance

HIGHER DIVIDEND OF 6.0 CENTS PER SHARE FOR 1H21

Total dividend payout since listing – **91.9 CENTS** per share

DIVIDEND PER SHARE (CENTS)



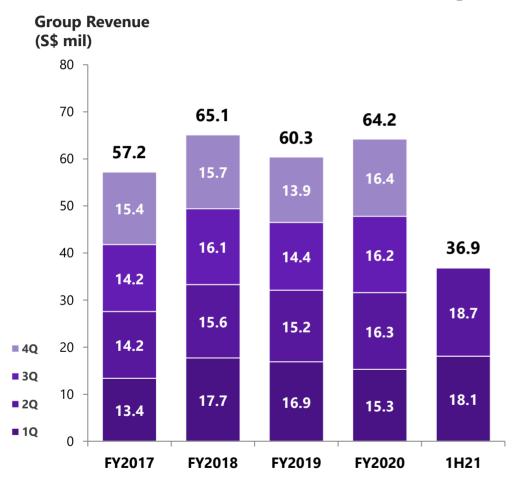
DIVIDEND PAYOUT RATIO

FY2003 FY2004 FY2005 FY2006 FY2007 FY2008 FY2009 FY2010 FY2011 FY2012 FY2013 FY2014 FY2015 FY2016 FY2017 FY2018 FY2019 FY2020 1H21 29% 63% 83% 78% 513% 87% 99% 81% **75%** 81% 107% 114% 92%

Dividend Policy of Not Less Than 40% of Earnings*

Group Revenue

YOY GROWTH IN QUARTERLY REVENUE SINCE 2Q20



2Q21 REVENUE **15.2%**

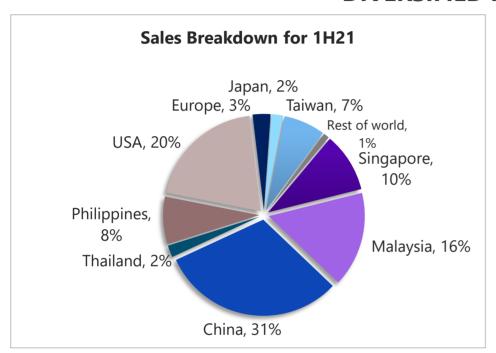
 Reflects the buoyant growth of the semiconductor industry

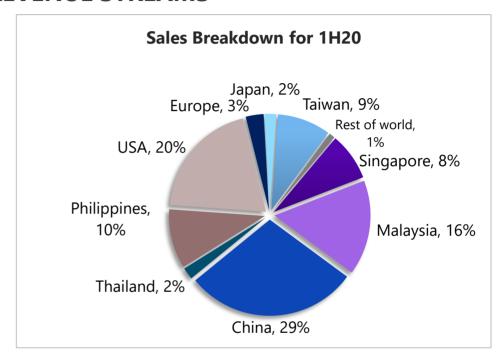
1H21 REVENUE **16.7%**

- Achieved record half-year sales in 1H21
- Registered higher sales in most of our geographical markets

Group Revenue

DIVERSIFIED REVENUE STREAMS



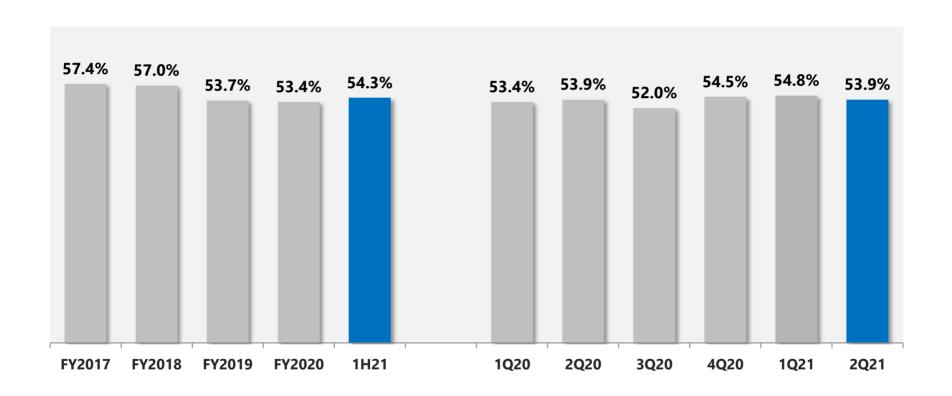


TOP 3 MARKETS

Country	1H21 S\$ mil	1H20 S\$ mil	% change
China	11.3	9.2	22%
USA	7.5	6.2	21%
Malaysia	5.8	5.1	13%

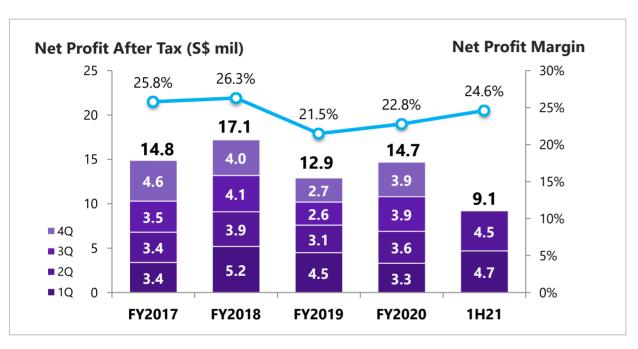
Gross Profit Margin

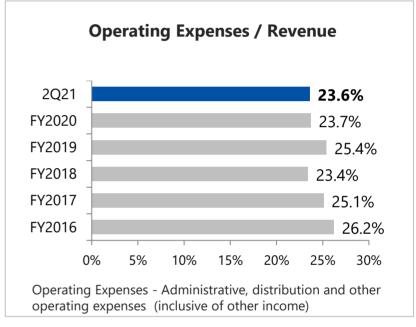
GROSS PROFIT MARGIN REMAINED ABOVE 50%



Profitability

ROBUST BOTTOMLINE GROWTH





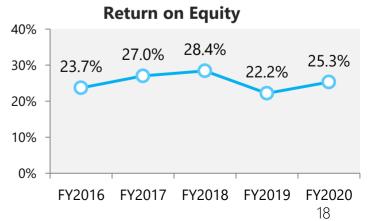




1H21 PROFIT

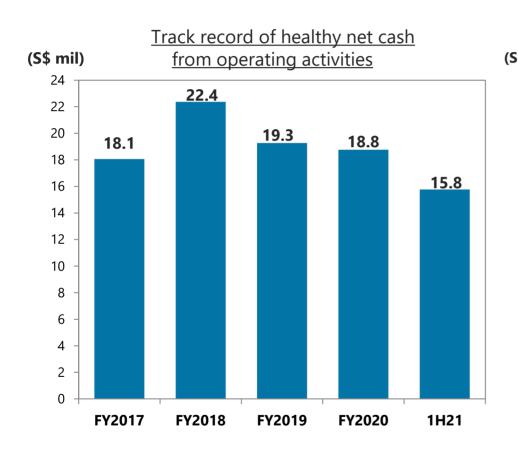


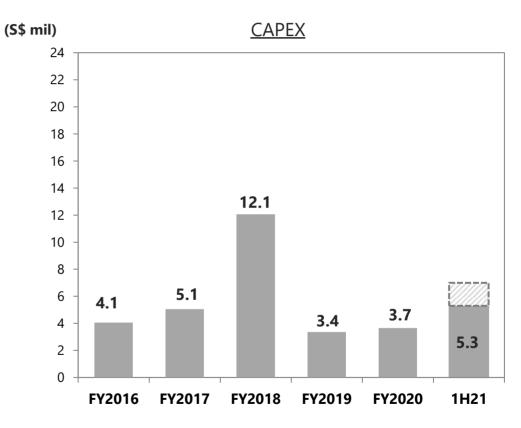
- Attributed to higher sales and GP, combined with a tight rein on expenses
- Steady year-on-year growth in profit from 2Q20 to 2Q21
- Achieved record profit in 1H21



Cash Flow

CASH-FLOW GENERATIVE OPERATIONS





Capex budget for FY2021 – approx. S\$7M

Balance Sheet

		31 December 2020	30 June 2020
<u>Cash</u>	Cash and cash equivalents#	S\$21.1M	S\$20.8M
Gearing	Total borrowings	Nil	Nil
<u>Trade Receivables</u>	Trade Receivables (Outstanding > 90days) / (Total trade receivables) Bad debt expense	S\$12.0M 0.03% Nil (1H21)	S\$11.8M 0.0% Nil (1H20)
<u>Inventory</u>	Inventory Inventory / Sales Inventory write-off	S\$4.8M 6.5% S\$42k (2Q21)	S\$5.4M 8.4% S\$27k (2Q20)
<u>Equity</u>	Shareholders' equity# NAV per share	S\$57.0M 40.98 cents	S\$58.0M 41.71 cents

^{*} Paid final dividend totalling S\$9.7M for FY2020



Safe Harbour for Forward-Looking Statements

This presentation contains certain statements that are not statements of historical fact, i.e. forward-looking statements. Investors can identify some of these statements by forward-looking items such as 'expect', 'believe', 'plan', 'intend', 'estimate', 'anticipate', 'may', 'will', 'would', and 'could' or similar words. However, you should note that these words are not the exclusive means of identifying forward-looking statements. These forward-looking statements are based on current expectations, projections and assumptions about future events. Although Micro-Mechanics (Holdings) Ltd. believes that these expectations, projections, and assumptions are reasonable, these forward-looking statements are subject to the risks (whether known or unknown), uncertainties and assumptions about Micro-Mechanics (Holdings) Ltd. and its business operations.

Some of the key factors that could cause such differences are, among others, the following:

- changes in the political, social and economic conditions and regulatory environment in the jurisdictions where we conduct business or expect to conduct business;
- the risk that we may be unable to realise our anticipated growth strategies and expected internal growth;
- changes in and new developments in technologies and trends;
- changes in currency exchange rates;
- changes in customer preferences and needs;
- changes in competitive conditions in the semiconductor industry and our ability to compete under these conditions;
- changes in pricing for our products; and
- changes in our future capital needs and the availability of financing and capital to fund these needs.

Given these risks, uncertainties and assumptions, the forward-looking events referred to in this presentation may not occur and actual results may differ materially from those expressly or impliedly anticipated in these forward-looking statements. Investors are advised not to place undue reliance on these forward-looking statements.

Investors should assume that the information in this presentation is accurate only as of the date it is issued. Micro-Mechanics (Holdings) Ltd.'s business, financial conditions, results of operations and prospects may have changed since that day. Micro-Mechanics (Holdings) Ltd. has no obligation to update or revise any forward-looking statement, whether as a result of new information, future events or otherwise, except as required by law.



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